

## PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Kazuki DENPOH</td> <td>07/16/2013</td> </tr> <tr> <td>Peter L G VENTZEK</td> <td>07/11/2013</td> </tr> <tr> <td>Lee CHEN</td> <td>07/17/2013</td> </tr> <tr> <td>Lin XU</td> <td>07/16/2013</td> </tr> </tbody> </table>		Name	Execution Date	Kazuki DENPOH	07/16/2013	Peter L G VENTZEK	07/11/2013	Lee CHEN	07/17/2013	Lin XU	07/16/2013		
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CORRESPONDENCE DATA													
<p>Fax Number:</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: (480) 539-2102</p> <p>Email: TEHIPDocket@us.tel.com</p> <p>Correspondent Name: Tokyo Electron U.S. Holdings, Inc.</p> <p>Address Line 1: 2545 W. Frye Rd.</p> <p>Address Line 2: Suite 1</p> <p>Address Line 4: Chandler, ARIZONA 85224</p>													
ATTORNEY DOCKET NUMBER:	TTCA-252DIV												
NAME OF SUBMITTER:	Andrej MITROVIC												

Signature:	/Andrej MITROVIC/
Date:	07/28/2013
	This document serves as an Oath/Declaration (37 CFR 1.63).
<p>Total Attachments: 8 source=DeclarationAssignmentP#page1.tif source=DeclarationAssignmentP#page2.tif source=DeclarationAssignmentP#page3.tif source=DeclarationAssignmentP#page4.tif source=DeclarationAssignmentP#page5.tif source=DeclarationAssignmentP#page6.tif source=DeclarationAssignmentP#page7.tif source=DeclarationAssignmentP#page8.tif</p>	

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN  
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT**

**Title of Invention:** HOLLOW CATHODE DEVICE AND METHOD FOR USING THE DEVICE  
TO CONTROL THE UNIFORMITY OF A PLASMA PROCESS

As a below named inventor, I hereby declare that:

This declaration is directed to:

☐ The attached application, or  
☒ United States application number or PCT international application number  
13/854,910 filed on April 1, 2013

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention  
in the above-identified application.

I have reviewed and understand the contents of the above-identified application,  
including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all  
information known to me to be material to patentability as defined in 37 C.F.R. § 1.56.

I hereby acknowledge that any willful false statement made in this Declaration is  
punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or  
both.

**Assignor(s):** The Assignor(s) is/are the undersigned inventor(s). The undersigned inventor(s)  
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As an undersigned inventor, I hereby assign to the ASSIGNEE my entire worldwide right,  
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(1) Legal name of Inventor: Kazuki DENPOH  
 Inventor's Signature: Kazuki Denpoh Date: July 16, 2013  
 Residence City/State/Country: Kai-City, Japan  
 Mailing Address: 3100-26 Ryuji, Kai-City, 260-0104, Japan  
 Citizenship: Japan

(2) Legal name of Inventor: Peter L G VENTZEK  
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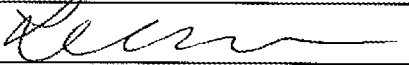
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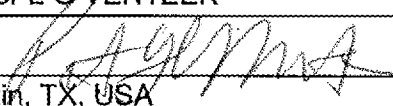
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